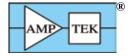
# This is the true State-of-the-Art!



Ultra High Performance Silicon Drift Detector



Amptek recently brought silicon wafer manufacturing in-house and improved the process. The result is a detector with lower noise, lower leakage current, better charge collection, and uniformity from detector to detector. This makes it the best performing silicon drift detector available and the true state-of-the-art.

The FAST SDD<sup>®</sup> represents Amptek's highest performance silicon drift detector (SDD), capable of count rates over 1,000,000 CPS (counts per second) while maintaining excellent resolution. The FAST SDD<sup>®</sup> is also available with our C-Series (Si3N4) low energy windows for soft x-ray analysis.

#### **Features**

- 25 mm<sup>2</sup> active area collimated to 17 mm<sup>2</sup>
- Also available 70 mm<sup>2</sup> collimated to 50 mm<sup>2</sup>
- 122 eV FWHM resolution at 5.9 keV
- Count rates > 1,000,000 CPS
- High peak-to-background ratio 26,000/1
- Preamplifier Output Rise Time <35 ns
- Windows: Be (0.5 mil) 12.5 μm, or C Series (Si3N4)
- Radiation hard
- Detector thickness 500 μm
- TO-8 Package
- Cooling ∆T>85 K
- Multilayer Collimator

#### **Applications**

- Ultra-fast benchtop and handheld XRF analyzers
- Scanning/mapping of samples in an SEM as part of an EDS system
- On-line process control
- X-Ray Sorting Machines
- OEM

#### The True State-of-the-Art

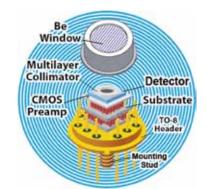
- Lower noise → Better resolution down to 122 eV FWHM
- Lower leakage current → Higher temperature operation (save battery life)
- Better charge collection → Better photopeak shape (no tailing)
- Quality → Detectors have consistent performance allowing for easier calibrations

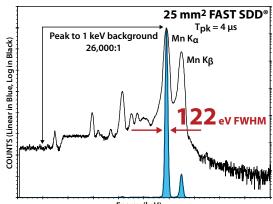
#### **Overview**

Unlike our conventional SDDs which use a junction gate field-effect transistor (JFET) inside the hermetically sealed TO-8 package, along with an external preamplifier, the FAST SDD uses a complementary metal-oxide-semiconductor (CMOS) preamplifier inside the TO-8 package, and replaces the JFET with a metal-oxide-semiconductor field-effect transistor (MOSFET). This significantly reduces capacitance, providing much lower series noise and yielding improved resolution at very short peaking times. The FAST SDD<sup>®</sup> uses the same detector but with a preamplifier giving lower noise at short peaking times. Improved (lower) resolution enables isolation/separation of fluorescent X-rays with close energy values where peaks would otherwise overlap, permitting users better identification all of the elements in their sample(s). Short peaking times also yield significant improvements in count rates; more counts provide better statistics.









Energy (keV)



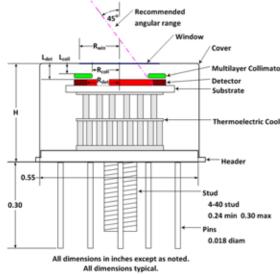
AMPTEK INC. Amptek.sales@ametek.com www.amptek.com

## Specifications

General					
Detector Type	Silicon Drift Detector (SDD) with CMOS preamplifier				
Detector Size	25 mm <sup>2</sup> - collimated to 17 mm <sup>2</sup> Also available 70 mm <sup>2</sup> - collimated to 50 mm <sup>2</sup>				
Silicon Thickness	500 μm				
Collimator	Internal Multilayer Collimator (ML)				
Energy Resolution @ 5.9 keV (55Fe)	122 - 129 eV FWHM at 4 μs peaking time (guaranteed)				
Peak to Back- ground	20000:1 (ratio of counts from 5.9 keV to 1 keV) (typical)				
Detector Window Options	Beryllium (Be): 0.5 mil (12.5 μm or 0.3 mil (8 μm) C Series (Si3N4) Low energy windows				
Charge Sensitive Preamplifier	CMOS				
Gain Stability	<20 ppm/°C (typical)				
Size Detector Module XR100 Box X-123 Box OEM	TO-8 package (0.640 in. high including pins, 0.600 in. diameter) 3.00 x 1.75 x 1.13 in (7.6 x 4.4 x 2.9 cm) 3.94 x 2.67 x 1.0 in (10.0 x 6.78 x 2.54 cm) Configurations vary				
Weight Detector Module XR100 Box X-123 Box OEM	0.14 ox (4.1 g) 4.4 oz (125 g) 6.3 oz (180 g) Configurations vary				
Total Power	<2 Watt				
Warranty Period	1 Year				
Device Lifetime	Typical 5 to 10 years, depending on use				
Operation condi- tions	-35°C to +80°C				

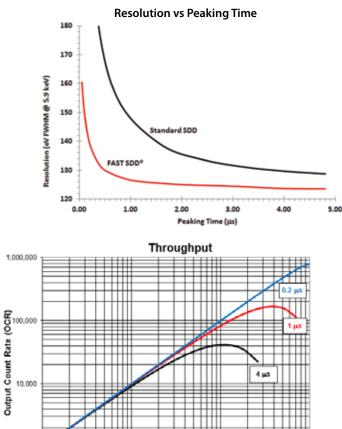
10+ years in dry environment					
-40°C to +85°C, 10 to 90% humidity					
noncondensing					
TUV Certification					
Certificate #: CU 72072412 02					
Tested to: UL 61010-1: 2004 R7 .05					
CAN/CSA-C22.2 61010-1: 2004					
XR-100SDD Inputs					
XR100 configuration: ±8 V @ 15 mA					
with no more than 50 mV peak-to-					
peak noise					
OEM configuration (PA210/230 or					
X-123): ±5 V					
-100 to -180 V @ 25 μA, very stable					
<0.1% variation					
450 mA maximum					
3.5 V maximum with <100 mV peak-to-					
peak noise					
DD includes its own temperature controller					
3.6 mV/keV typical (may vary for differ-					
ent detectors)					
Positive signal output (1 k $\Omega$ max. load)					
Reset					
Varies with configuration					
When used with PX5, DP5, or X-123:					
direct reading in Kelvin through soft-					
ware.					
<35 ns					

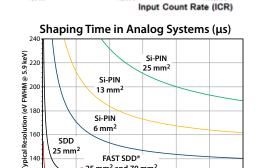
#### **Detector Geometry**



	Detector Type	Area/Thickness	R <sub>det</sub> (mm)	A <sub>det</sub> (mm²)	R <sub>coll</sub> (mm)	A <sub>coll</sub> (mm²)	L <sub>coll</sub> (mm)	L <sub>coll</sub> (mm)
r	SDD	25 mm²/500 μm	2.82	25.0	2.33	17.0	0.9	1.4
	Si-PIN	6 mm²/500 μm	1.38	6.0	1.19	4.4	1.0	1.7
ler	Si-PIN	13 mm²/500 μm	2.03	13.0	1.88	11.1	1.0	1.7
	Si-PIN	25 mm²/500 μm	2.82	25.0	2.62	21.5	1.0	1.7

#### Performance





FAST SDD®

25 mm<sup>2</sup> and 70 mm<sup>2</sup>

15 Peaking Time (µs)

20

10,000

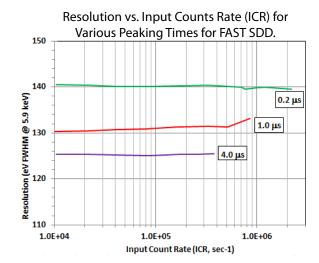
100,000

1,000,000

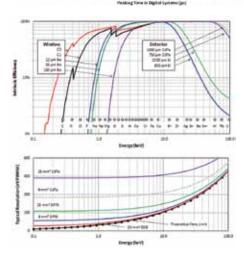
1,000 1,000



Resolution	Peaking Time
124 eV FWHM	4 µs
126 eV FWHM	1 µs
139 eV FWHM	0.2 μs
160 eV FWHM	0.05 μs



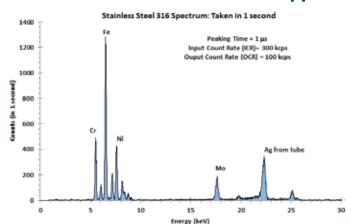
Energy Resolution and Count Rate: This plot shows how the energy resolution at 5.9 keV is related to the output count rate for Amptek's X-ray detectors, as a function of the pulse shaping time and the equivalent peaking time in a digital processor. These are typical values at full cooling (220K). For example, at a  $T_{_{peak}}$  of 9.6 microseconds (equivalent to 4.0 microsecond pulse shaping time) the output count rate at 50% dead time is 18 kcps. This is a function only of the pulse processing so is the same for all detectors. The energy resolution for a 6 mm<sup>2</sup> Si-PIN is just under 160 eV FWHM while for a 25 mm<sup>2</sup> SDD it is 130 eV FWHM.

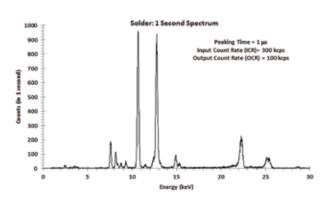


Energy resolution, efficiency, and X-ray energy: This plot shows how the intrinsic efficiency (top) and energy resolution (bottom) depend on the X-ray energy.

In the bottom plot, the black curve represents "Fano broadening", the theoretical limit with a Si based detectors, arising from quantum fluctuations in the charge production process. The colored curves represent the combination of Fano broadening and intrinsic electronic noise under optimum conditions (full cooling and long peaking time). The detector selection is most important at the lowest energies because Fano broadening dominates at high enough energies.

In the top plot, the efficiency at low energies is determined by transmission through the window and detector dead layer. The efficiency at high energies is determined by attenuation in the active depth of the detector. A Si detector with Be window is recommended between about 2 and 30 keV. A Si detector with a C1 or C2 window is recommended at lower energies, while a CdTe detector is best at energies above 30 keV.

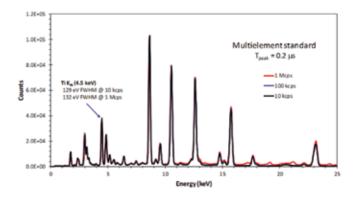




#### **Application Spectra**

The below table displays the quantitative analysis of the data from the figure at left.

		r		
Element	Certified Concentration	Fast SDD <sup>®</sup> Result in 1 s		
V	0.05	$0.16\pm0.28$		
Cr	18.45	$18.32 \pm 0.80$		
Mn	1.63	0.40 ± 0.55		
Fe	64.51	65.89 ± 1.64		
Co	0.10	$0.00 \pm 0.40$		
Ni	12.18	12.56 ± 0.47		
Cu	0.17	$0.19 \pm 0.02$		
Мо	2.38	$2.34\pm0.08$		



### **Configurations**

#### X-123FASTSDD®



**Complete X-Ray Spectrometer Includes:** 1 Silicon Drift Detector and Preamplifier 2 Digital Pulse Processor and MCA

**3 Power Supply** 

#### **FASTSDD® Vacuum Applications**



The FAST SDD with its preamplifier is available in several OEM configurations

#### XR-100FASTSDD®



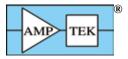
X-Ray Detector and Digital Pulse Processor with MCA



**Complete XRF System Includes:** X-123SDD Complete Spectrometer Mini-X USB Controlled X-Ray Tube **XRF-FP** Quantitative Analysis Software Test stand with shielding and sample enclosure







AMPTEK INC. 14 DeAngelo Drive, Bedford, MA 01730-2204 USA +1 781 275-2242 Amptek.sales@ametek.com www.amptek.com

**OEM FASTSDD®**